RoHS Compliant
1310 nm Single-mode Transceiver (S4.1, 20km)
1×9, SC Duplex Connector, 3.3 V
622 Mbps ATM/SONET OC-12/SDH STM-4

| **No Shield** | **Forward Clipper** | **Backward Clipper** |

Features

- Industry standard 1×9 footprint
- SC duplex connector
- Single power supply 3.3 V
- Differential LVPECL data inputs and outputs
- LVPECL Signal Detect output
- Compatible with solder and aqueous wash processes
- Class 1 laser product complies with EN 60825-1

Ordering Information

PART NUMBER	INPUT/OUTPUT	SIGNAL DETECT	VOLTAGE	CLIPPER	TEMPERATURE
LS32-B3S-PC-N	DC/DC	LVPECL/PECL	3.3V	---	$0\,^{\circ}$C to $70\,^{\circ}$C
LS32-B3S-PC-B	DC/DC	LVPECL/PECL	3.3V	Backward	$0\,^{\circ}$C to $70\,^{\circ}$C
LS32-B3S-PC-F	DC/DC	LVPECL/PECL	3.3V	Forward	$0\,^{\circ}$C to $70\,^{\circ}$C
LS32-B3S-TC-N	AC/AC	TTL	3.3V	---	$0\,^{\circ}$C to $70\,^{\circ}$C
LS32-B3S-TC-B	AC/AC	TTL	3.3V	Backward	$0\,^{\circ}$C to $70\,^{\circ}$C
LS32-B3S-TC-F	AC/AC	TTL	3.3V	Forward	$0\,^{\circ}$C to $70\,^{\circ}$C

Absolute Maximum Ratings

PARAMETER	SYMBOL	MIN	MAX	UNITS	NOTE
Storage Temperature	T_S	−40	85	$^\circ$C	
Supply Voltage	Vcc	−0.5	6.0	V	
Input Voltage	V_{IN}	−0.5	Vcc	V	
Output Current	I_o	---	50	mA	
Operating Current	I_{OP}	---	500	mA	
Soldering Temperature	T_{SOLD}	---	260	$^\circ$C	10 seconds on leads

Operating Environment

PARAMETER	SYMBOL	MIN	MAX	UNITS	NOTE
Case Operating Temperature	T_C	0	70	$^\circ$C	
Supply Voltage	Vcc	3.1	3.5	V	
Supply Current	$I_{TX} + I_{RX}$	---	250	mA	

Transmitter Electro-optical Characteristics

Vcc = 3.1 V to 3.5 V, T_C = 0 °C to 70 °C

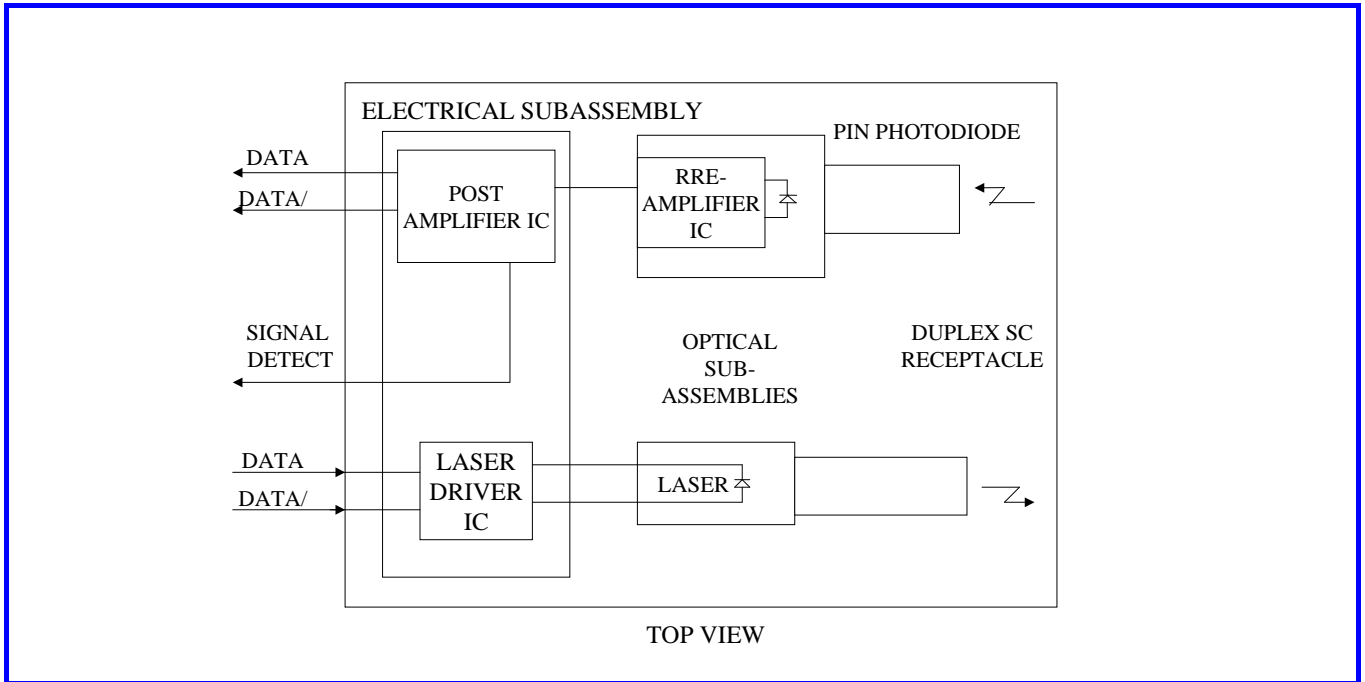| PARAMETER	SYMBOL	MIN	TYP.	MAX	UNITS	NOTE
Data Rate	B	500	622	700	Mb/s	
Output Optical Power 9/125 μm fiber	Pout	-15	---	-8	dBm	Average
Extinction Ratio	ER	8.2	---	---	dB	
Center Wavelength	λ_C	1280	1310	1355	nm	
Spectral Width (RMS)	$\Delta\lambda$	---	---	2.5	nm	
Rise/Fall Time (20–80%)	$T_{r,f}$	---	---	500	ps	
Total Jitter	TJ	---	---	500	ps	
Output Eye	Compliant with Telcordia GR-253-CORE Issue 3 and ITU-T recommendation G-957					
Transmitter Data Input Voltage-High	$V_{IH} - V_{CC}$	−1.1	---	−0.74	V	
Transmitter Data Input Voltage-Low	$V_{IL} - V_{CC}$	−2.0	---	−1.58	V	
Transmitter Data Input Differential Voltage	V_{DIFF}	0.3	---	1.6	V	

Receiver electro-optical characteristics

Vcc = 3.1 V to 3.5 V, T_C = 0 $^\circ$C to 70 $^\circ$C

PARAMETER	SYMBOL	MIN	TYP.	MAX	UNITS	NOTE
Optical Input Power-maximum	P_{IN}	-3	---	---	dBm	BER < 10^{-10}
Optical Input Power-minimum (Sensitivity)	P_{IN}	---	---	−28	dBm	BER < 10^{-10}
Operating Center wavelength	λ_C	1260	---	1610	nm	
Optical Return Loss	ORL	12	---	---	dB	
Signal Detect-Asserted	P_A	---	---	−28	dBm	
Signal Detect-Deasserted	P_D	−40	---	---	dBm	
Signal Detect-Hysteresis	$P_A - P_D$	1.0	---	---	dB	
Signal Detect Voltage (PECL)- High	$V_{OH} - V_{CC}$	−1.1	---	−0.74	V	
Signal Detect Voltage (PECL)- Low	$V_{OL} - V_{CC}$	−2.0	---	−1.58	V	
Signal Detect Voltage (TTL)-High	V_{OH}	V_{CC}−0.8	---	*Vcc*	V	
Signal Detect Voltage (TTL)-Low	V_{OL}	0	---	0.5	V	
Data Output Rise, Fall Time (20–80%)	$T_{r,f}$	---	---	0.35	ns	
Data Output Voltage-High	$V_{OH} - V_{CC}$	−1.1	---	−0.74	V	
Data Output Voltage-Low	$V_{OL} - V_{CC}$	−2.0	---	−1.58	V	
Data Output Differential Voltage	V_{DIFF}	0.3	---	1.6	V	

Block Diagram of Transceiver

ELECTRICAL SUBASSEMBLY

PIN PHOTODIODE

DATA

DATA/

POST AMPLIFIER IC

RRE-AMPLIFIER IC

SIGNAL DETECT

OPTICAL SUB-ASSEMBLIES

DUPLEX SC RECEPTACLE

DATA

DATA/

LASER DRIVER IC

LASER

TOP VIEW

Transmitter Section

The transmitter section consists of a 1310 nm InGaAsP laser in an eye safe optical subassembly (OSA) which mates to the fiber cable. The laser OSA is driven by a LD driver IC which converts differential input PECL logic signals into an analog laser driving current.

Receiver Section

The receiver utilizes an InGaAs PIN photodiode mounted together with a trans-impedance preamplifier IC in an OSA. This OSA is connected to a circuit providing post-amplification quantization, and optical signal detection.

Receiver Signal Detect

Signal Detect is a basic fiber failure indicator. This is a single-ended PECL output. As the input optical power is decreased, Signal Detect will switch from high to low (deassert point) somewhere between sensitivity and the no light input level. As the input optical power is increased from very low levels, Signal Detect will switch back from low to high (assert point). The assert level will be at least 1.0 dB higher than the deassert level.

Connection Diagram

Pin-Out

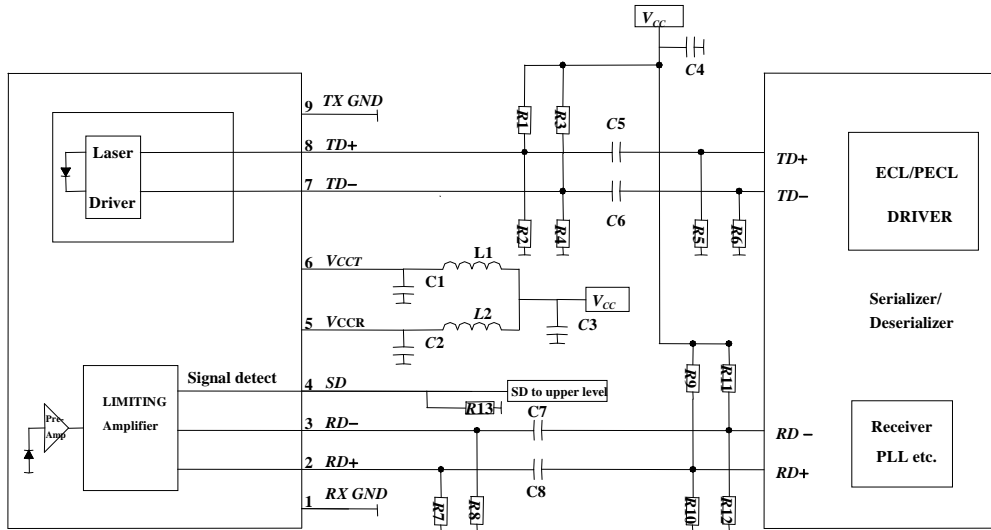| 1. *RX GND*	
2. *RD+*	N/C
3. *RD−*	
4. *SD*	**TOP VIEW**
5. *V_{CCR}*	
6. *V_{CCT}*	
7. *TD−*	
8. *TD+*	N/C
9. *TX GND*	

PIN	SYMBOL	DESCRIPTION
1	*RX GND*	Receiver Signal Ground. Directly connect this pin to the receiver ground plane.
2	*RD+*	*RD+* is an open-emitter output circuit. Terminate this high-speed differential PECL output with standard PECL techniques at the follow-on device input pin. (See recommended circuit schematic)
3	*RD−*	*RD–* is an open-emitter output circuit. Terminate this high-speed differential PECL output with standard PECL techniques at the follow-on device input pin. (See recommended circuit schematic)
4	*SD*	Signal Detect. Normal optical input levels to the receiver result in a logic "1" output, V_{OH}, asserted. Low input optical levels to the receiver result in a fault condition indicated by a logic "0" output V_{OL}, deasserted Signal Detect is a single-ended PECL output. *SD* can be terminated with PECL techniques via 50 Ω to $V_{CCR} - 2$ V. Alternatively, *SD* can be loaded with a 180 Ω resistor to *RX GND* to conserve electrical power with small compromise to signal quality. If Signal Detect output is not used, leave it open-circuited. This Signal Detect output can be used to drive a PECL input on an upstream circuit, such as, Signal Detect input or Loss of Signal-bar.
5	*V_{CCR}*	Receiver Power Supply. Provide +3.3 Vdc via the recommended receiver power supply filter circuit. Locate the power supply filter circuit as close as possible to the V_{CCR} pin.
6	*V_{CCT}*	Transmitter Power Supply. Provide +3.3 Vdc via the recommended transmitter power supply filter circuit. Locate the power supply filter circuit as close as possible to the V_{CCT} pin.
7	*TD−*	Transmitter Data In-Bar. Terminate this high-speed differential PECL input with standard PECL techniques at the transmitter input pin. (See recommended circuit schematic)
8	*TD+*	Transmitter Data In. Terminate this high-speed differential PECL input with standard PECL techniques at the transmitter input pin. (See recommended circuit schematic)
9	*TX GND*	Transmitter Signal Ground. Directly connect this pin to the transmitter signal ground plane. Directly connect this pin to the transmitter ground plane.

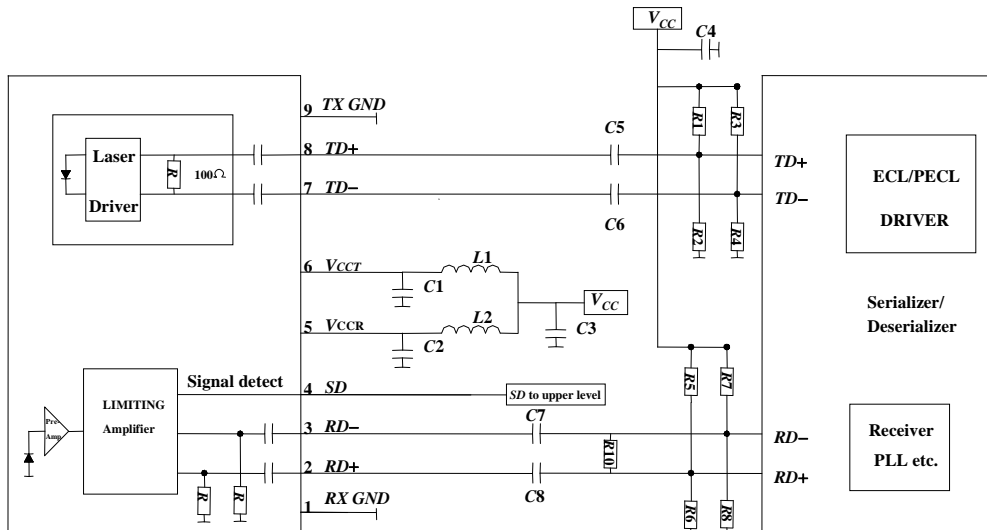## Recommended Circuit Schematic

DC/DC Coupling

$C1/C2/C4/C5/C6/C7/C8 = 100$ nF $C3 = 4.7\ \mu$F   L1/L2 = 1 μH
$R1/R3 = 82\Omega$ $R2/R4 = 130\ \Omega$ $R7/R8 = 180\ \Omega$
$R13 = 180\ \Omega$ (PECL) $R5/R6/R9/R10/R11/R12$ Depend on SerDes

AC/AC Coupling

$C1/C2/C4/C5/C6/C7/C8 = 100$ nF $C3 = 4.7\ \mu$F   L1/L2 = 1μH
$R1/R2/R3/R4/R5/R6/R7/R8$ Depend on SerDes

In order to get proper functionality, a recommended circuit is provided in above recommended circuit schematic. When designing the circuit interface, there are a few fundamental guidelines to follow.

(1) The differential data lines should be treated as 50 Ω Micro strip or strip line transmission lines. This will help to minimize the parasitic inductance and capacitance effects. Locate termination at the received signal end of the transmission line. The length of these lines should be kept short and of equal length.

(2) For the high speed signal lines, differential signals should be used, not single-ended signals, and these differential signals need to be loaded symmetrically to prevent unbalanced currents which will cause distortion in the signal.

(3) Multi layer plane PCB is best for distribution of V_{CC}, returning ground currents, forming transmission lines and shielding, Also, it is important to suppress noise from influencing the fiber-optic transceiver performance, especially the receiver circuit.

(4) A separate proper power supply filter circuits shown in Figure for the transmitter and receiver sections. These filter circuits suppress Vcc noise over a broad frequency range, this prevents receiver sensitivity degradation due to V_{CC} noise.

(5) Surface-mount components are recommended. Use ceramic bypass capacitors for the 0.1 μF capacitors and a surface-mount coil inductor for 1 μH inductor. Ferrite beads can be used to replace the coil inductors when using quieter V_{CC} supplies, but a coil inductor is recommended over a ferrite bead. All power supply components need to be placed physically next to the V_{CC} pins of the receiver and transmitter.

(6) Use a good, uniform ground plane with a minimum number of holes to provide a low-inductance ground current return for the power supply currents.

Recommended Board Layout Hole Pattern


Unit : mm(inches)
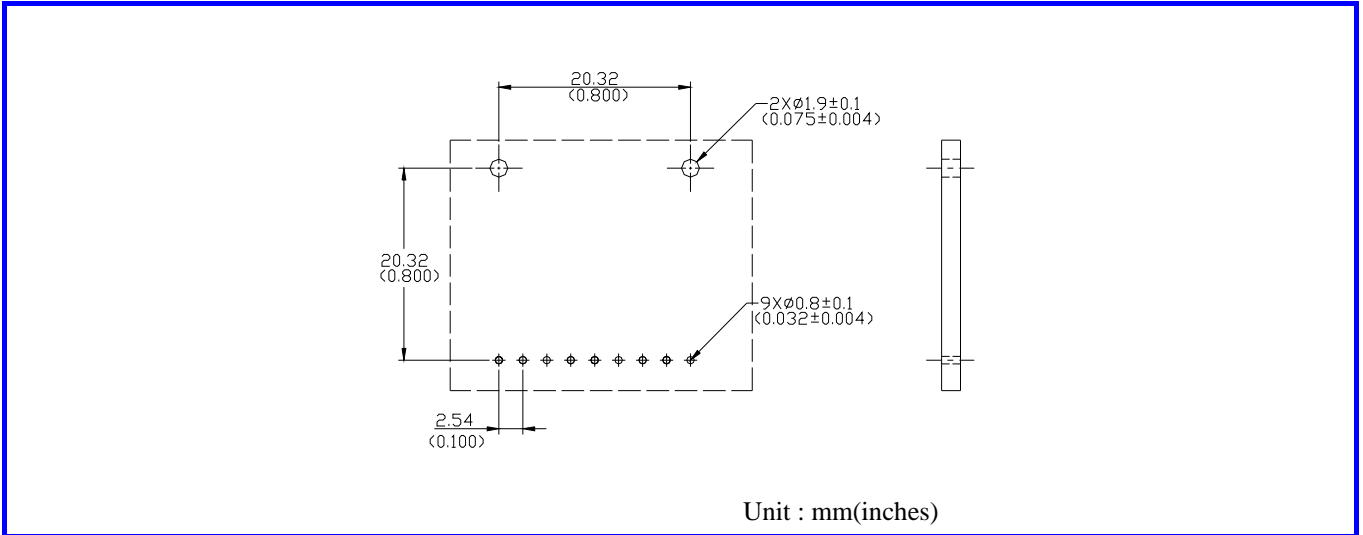
    This transceiver is compatible with industry standard wave or hand solder processes. After wash process, all moisture must be completely remove from the module. The transceiver is supplied with a process plug to prevent contamination during wave solder and aqueous rinse as well as during handling, shipping or storage.

    Solder fluxes should be water-soluble, organic solder fluxes. Recommended cleaning and degreasing chemicals for these transceivers are alcohol's (methyl, isopropyl, isobutyl), aliphatics (hexane, heptane) and other chemicals, such as soap solution or naphtha. Do not use partially halogenated hydrocarbons for cleaning/degreasing.
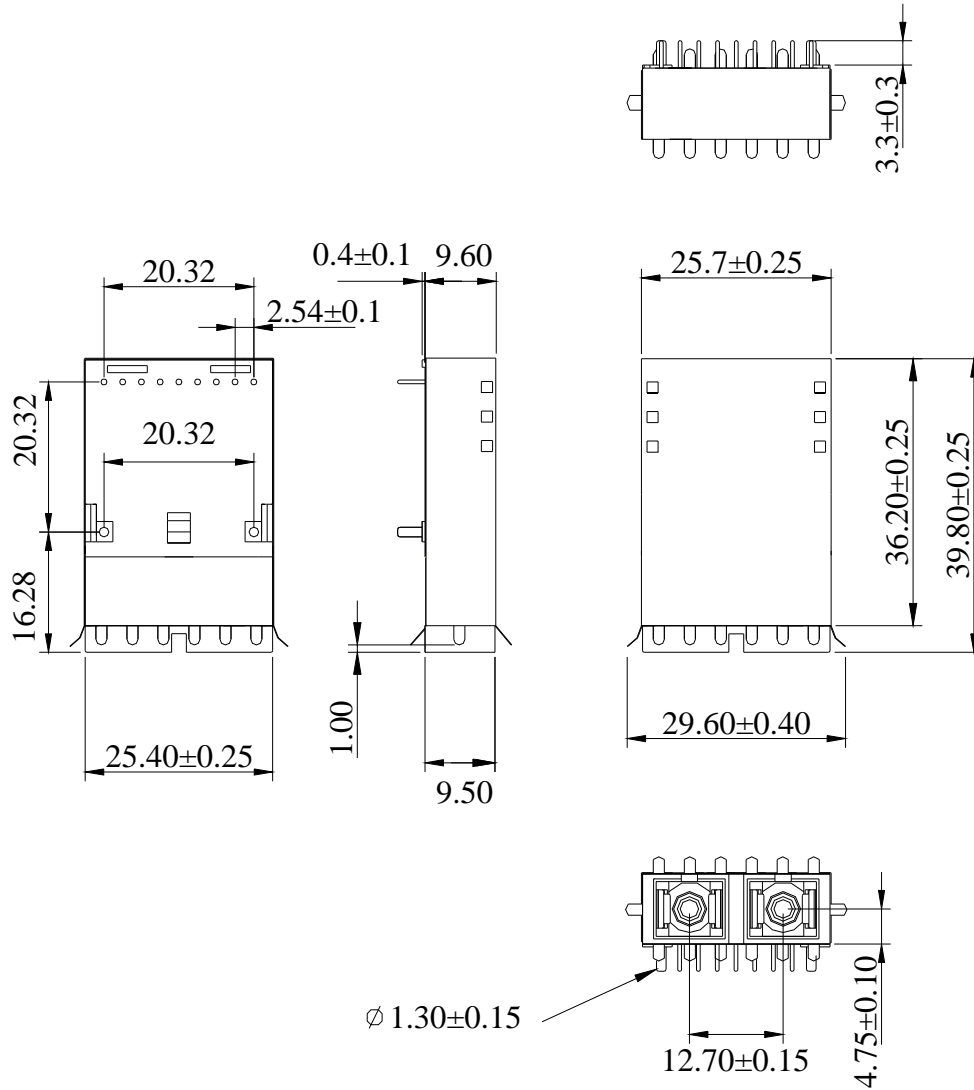
Drawing Dimensions- No Shield
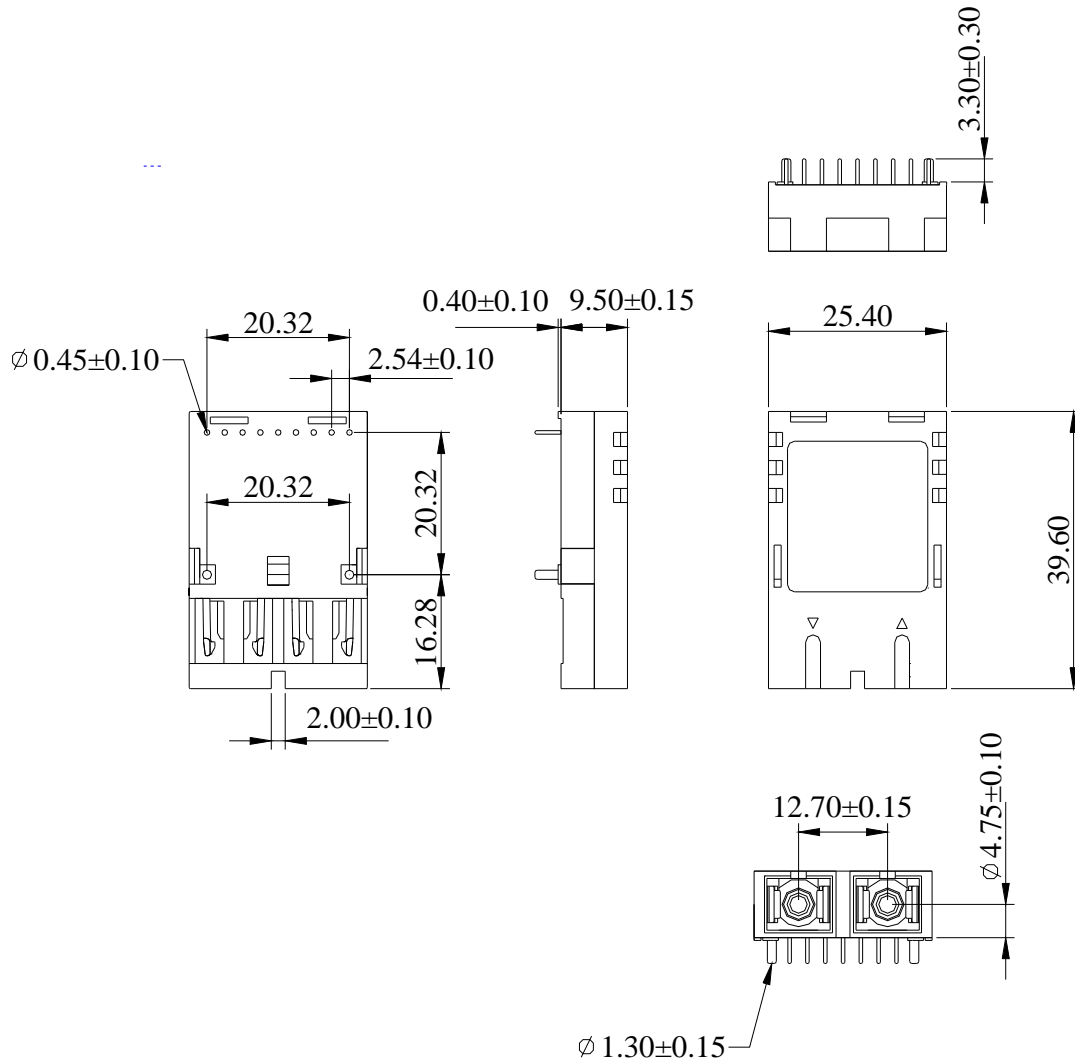
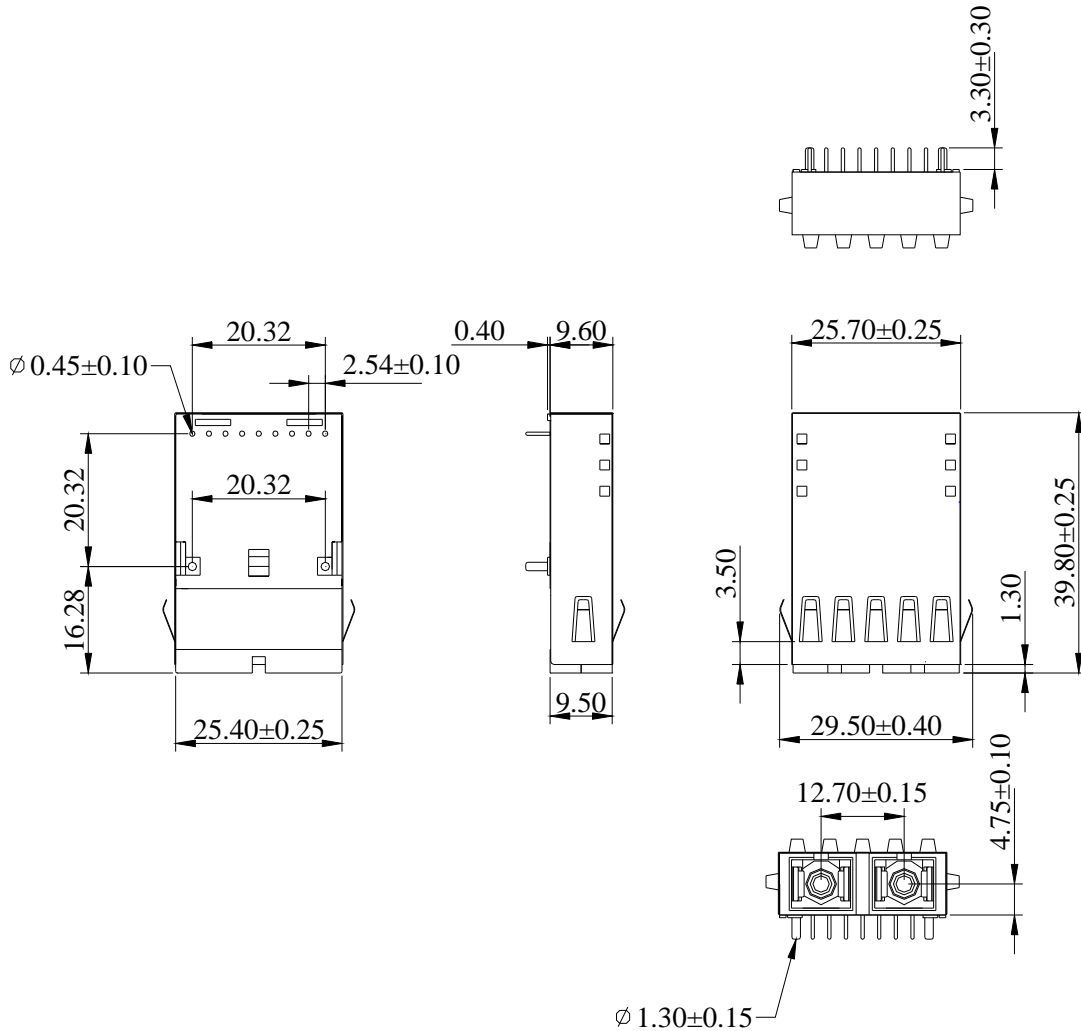ALL DIMENSIONS ARE±0.20mm UNLESS OTHERWISE SPECIFIED

Unit: mm

Drawing Dimensions- Forward Shield

ALL DIMENSIONS ARE±0.2mm UNLESS OTHERWISE SPECIFIED

Unit: mm

Drawing Dimensions- Backward Shield

ALL DIMENSIONS ARE±0.20mm UNLESS OTHERWISE SPECIFIED

Unit: mm

Eye Safety Mark

The LS3 series Single-mode transceiver is a class 1 laser product. It complies with EN 60825-1 and FDA 21 CFR 1040.10 and 1040.11. In order to meet laser safety requirements the transceiver shall be operated within the Absolute Maximum Ratings.

Caution
All adjustments have been done at the factory before the shipment of the devices. No maintenance and user serviceable part is required. Tampering with and modifying the performance of the device will result in voided product warranty.

<u>Required Mark</u>

Class 1 Laser Product
Complies with
21 CFR 1040.10 and 1040.11

Note : All information contained in this document is subject to change without notice.